Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

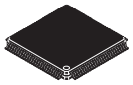
Contact us

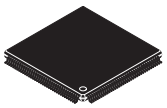
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

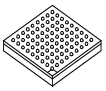
Freescale Semiconductor
Data Sheet: Technical Data

Document Number: MCF52235
Rev. 10, 3/2011

MCF52235


LQFP-80
14mm x 14mm


LQFP-112
20mm_x_20mm


MAPBGA-121
12mm_x_12mm

MCF52235 ColdFire Microcontroller Data Sheet

Supports MCF52230, MCF52231, MCF52232, MCF52233, MCF52234, MCF52235, and MCF52236

The MCF52235 is a member of the ColdFire® family of reduced instruction set computing (RISC) microcontrollers. This document provides an overview of the MCF52235 microcontroller family, focusing on its highly integrated and diverse feature set.

This 32-bit device is based on the Version 2 ColdFire core operating at a frequency up to 60 MHz, offering high performance and low power consumption. On-chip memories connected tightly to the processor core include up to 256 Kbytes of Flash and 32 Kbytes of static random access memory (SRAM). On-chip modules include:

- V2 ColdFire core providing 56 Dhrystone 2.1 MIPS @ 60 MHz executing out of on-chip Flash memory using enhanced multiply accumulate (EMAC) and hardware divider
- Enhanced Multiply Accumulate Unit (EMAC) and hardware divide module
- Cryptographic Acceleration Unit (CAU) coprocessor
- Fast Ethernet Controller (FEC)
- On-chip Ethernet Transceiver (EPHY)
- FlexCAN controller area network (CAN) module
- Three universal asynchronous/synchronous receiver/transmitters (UARTs)
- Inter-integrated circuit (I^2C™) bus controller
- Queued serial peripheral interface (QSPI) module
- Eight-channel 10- or 12-bit fast analog-to-digital converter (ADC)
- Four channel direct memory access (DMA) controller
- Four 32-bit input capture/output compare timers with DMA support (DTIM)
- Four-channel general-purpose timer (GPT) capable of input capture/output compare, pulse width modulation (PWM) and pulse accumulation
- Eight/Four-channel 8/16-bit pulse width modulation timers (two adjacent 8-bit PWMs can be concatenated to form a single 16-bit timer)
- Two 16-bit periodic interrupt timers (PITs)
- Real-time clock (RTC) module
- Programmable software watchdog timer
- Two interrupt controllers providing every peripheral with a unique selectable-priority interrupt vector plus seven external interrupts with fixed levels/priorities
- Clock module with support for crystal or external oscillator and integrated phase-locked loop (PLL)
- Test access/debug port (JTAG, BDM)

Table of Contents

List of Figures

List of Tables

1 MCF52235 Family Configurations

Table 1. MCF52235 Family Configurations

Module	52230	52231	52232	52233	52234	52235	52236
Version 2 ColdFire Core with EMAC (Enhanced Multiply-Accumulate Unit)	•	•	•	•	•	•	•
System Clock (MHz)	60	60	50	60	60	60	50
Performance (Dhrystone 2.1 MIPS)	56	56	46	56	56	56	46
Flash / Static RAM (SRAM)	128/32 Kbytes	128/32 Kbytes	128/32 Kbytes	256/32 Kbytes	256/32 Kbytes	256/32 Kbytes	256/32 Kbytes
Interrupt Controllers (INTC0/INTC1)	•	•	•	•	•	•	•
Fast Analog-to-Digital Converter (ADC)	•	•	•	•	•	•	•
Random Number Generator and Crypto Acceleration Unit (CAU)	—	—	—	—	—	•	—
FlexCAN 2.0B Module	—	•	—	—	•	•	—
Fast Ethernet Controller (FEC) with on-chip interface (EPHY)	•	•	•	•	•	•	•
Four-channel Direct-Memory Access (DMA)	•	•	•	•	•	•	•
Software Watchdog Timer (WDT)	•	•	•	•	•	•	•
Programmable Interrupt Timer	2	2	2	2	2	2	2
Four-Channel General Purpose Timer	•	•	•	•	•	•	•
32-bit DMA Timers	4	4	4	4	4	4	4
QSPI	•	•	•	•	•	•	•
UART(s)	3	3	3	3	3	3	3
I^2C	•	•	•	•	•	•	•
Eight/Four-channel 8/16-bit PWM Timer	•	•	•	•	•	•	•
General Purpose I/O Module (GPIO)	•	•	•	•	•	•	•
Chip Configuration and Reset Controller Module	•	•	•	•	•	•	•
Background Debug Mode (BDM)	•	•	•	•	•	•	•
JTAG - IEEE 1149.1 Test Access Port[1]	•	•	•	•	•	•	•
Package	80 LQFP 112 LQFP	80 LQFP 112 LQFP	80 LQFP	80 LQFP 112 LQFP	112 LQFP 121 MAPBGA	112 LQFP 121 MAPBGA	80 LQFP

[1] The full debug/trace interface is available only on the 112- and 121-pin packages. A reduced debug interface is bonded on the 80-pin package.

1.1 Block Diagram

The MCF52235 (or its variants) comes in 80- and 112-pin low-profile quad flat pack packages (LQFP) and a 121 MAPBGA, and operates in single-chip mode only. Figure 1 shows a top-level block diagram of the MCF52235.

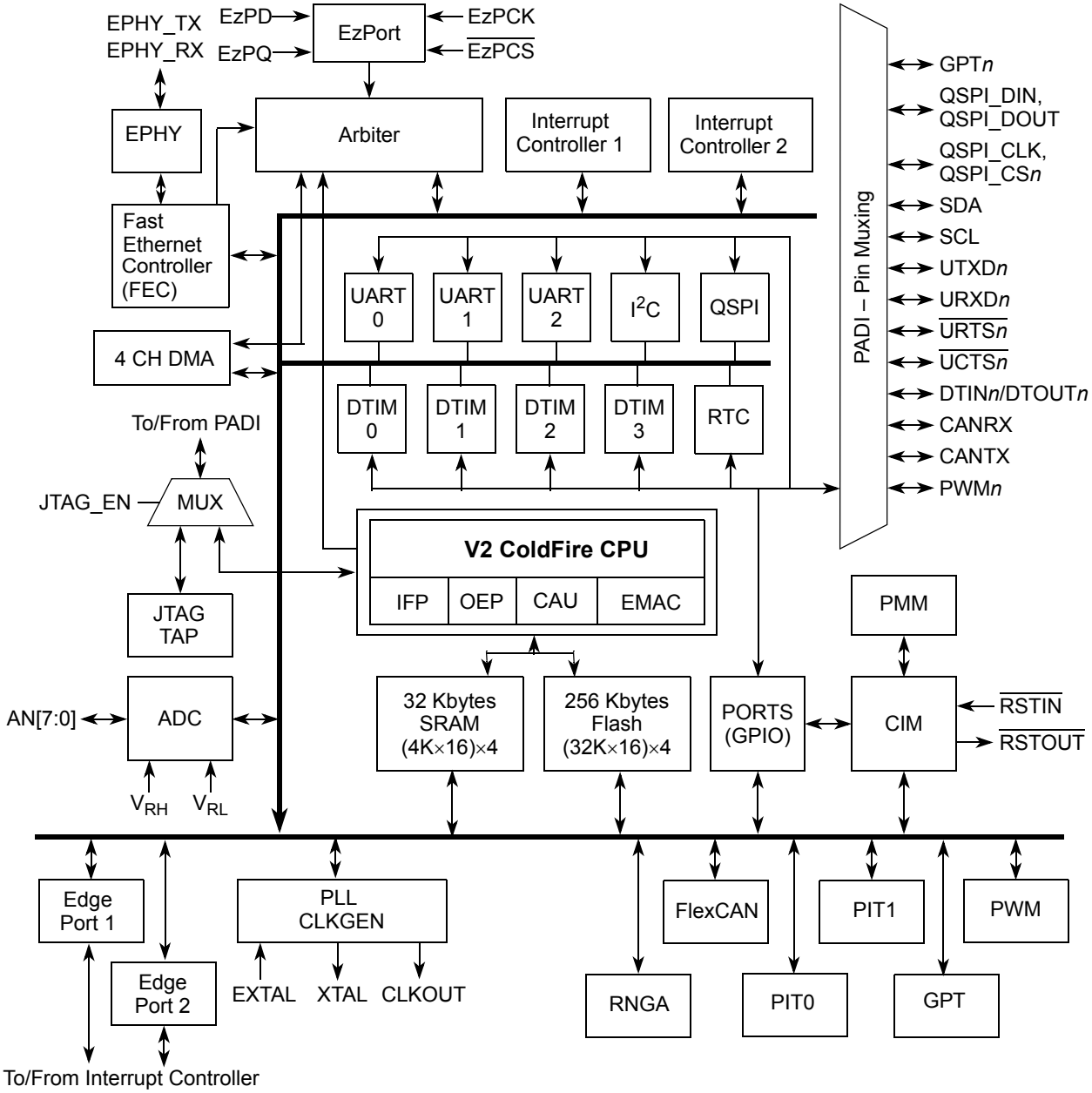


Figure 1. MCF52235 Block Diagram

1.2 Features

This document contains information on a new product under development. Freescale reserves the right to change or discontinue this product without notice. Specifications and information herein are subject to change without notice.

1.2.1 Feature Overview

The MCF52235 family includes the following features:

- Version 2 ColdFire variable-length RISC processor core
  - Static operation
  - 32-bit address and data paths on-chip
  - Up to 60 MHz processor core frequency
  - Sixteen general-purpose, 32-bit data and address registers
  - Implements ColdFire ISA_A with extensions to support the user stack pointer register and four new instructions for improved bit processing (ISA_A+)
  - Enhanced Multiply-Accumulate (EMAC) unit with 32-bit accumulator to support 16 × 16 → 32 or 32 × 32 → 32 operations
  - Cryptography Acceleration Unit (CAU)
    - Tightly-coupled coprocessor to accelerate software-based encryption and message digest functions
    - FIPS-140 compliant random number generator
  - Support for DES, 3DES, AES, MD5, and SHA-1 algorithms
  - Illegal instruction decode that allows for 68K emulation support
- System debug support
  - Real time trace for determining dynamic execution path
  - Background debug mode (BDM) for in-circuit debugging (DEBUG_B+)
  - Real time debug support, with six hardware breakpoints (4 PC, 1 address and 1 data) that can be configured into a 1- or 2-level trigger
- On-chip memories
  - Up to 32 Kbytes of dual-ported SRAM on CPU internal bus, supporting core and DMA access with standby power supply support
  - Up to 256 Kbytes of interleaved Flash memory supporting 2-1-1-1 accesses
- Power management
  - Fully static operation with processor sleep and whole chip stop modes
  - Rapid response to interrupts from the low-power sleep mode (wake-up feature)
  - Clock enable/disable for each peripheral when not used
- Fast Ethernet Controller (FEC)
  - 10/100 BaseT/TX capability, half duplex or full duplex
  - On-chip transmit and receive FIFOs
  - Built-in dedicated DMA controller
  - Memory-based flexible descriptor rings
- On-chip Ethernet Transceiver (EPHY)
  - Digital adaptive equalization
  - Supports auto-negotiation
  - Baseline wander correction
  - Full-/Half-duplex support in all modes
  - Loopback modes
  - Supports MDIO preamble suppression
  - Jumbo packet
- FlexCAN 2.0B module

- Based on and includes all existing features of the Freescale TouCAN module
- Full implementation of the CAN protocol specification version 2.0B
  - Standard Data and Remote Frames (up to 109 bits long)
  - Extended Data and Remote Frames (up to 127 bits long)
  - 0–8 bytes data length
  - Programmable bit rate up to 1 Mbit/sec
- Flexible Message Buffers (MBs), totalling up to 16 message buffers of 0–8 byte data length each, configurable as Rx or Tx, all supporting standard and extended messages
- Unused Message Buffer space can be used as general purpose RAM space
- Listen only mode capability
- Content-related addressing
- No read/write semaphores required
- Three programmable mask registers: global for MBs 0-13, special for MB14, and special for MB15
- Programmable transmit-first scheme: lowest ID or lowest buffer number
- Time stamp based on 16-bit free-running timer
- Global network time, synchronized by a specific message
- Maskable interrupts

- Three universal asynchronous/synchronous receiver transmitters (UARTs)
  - 16-bit divider for clock generation
  - Interrupt control logic with maskable interrupts
  - DMA support
  - Data formats can be 5, 6, 7 or 8 bits with even, odd or no parity
  - Up to 2 stop bits in 1/16 increments
  - Error-detection capabilities
  - Modem support includes request-to-send (RTS) and clear-to-send (CTS) lines for two UARTs
  - Transmit and receive FIFO buffers
- I^2C module
  - Interchip bus interface for EEPROMs, LCD controllers, A/D converters, and keypads
  - Fully compatible with industry-standard I^2C bus
  - Master and slave modes support multiple masters
  - Automatic interrupt generation with programmable level
- Queued serial peripheral interface (QSPI)
  - Full-duplex, three-wire synchronous transfers
  - Up to four chip selects available
  - Master mode operation only
  - Programmable bit rates up to half the CPU clock frequency
  - Up to 16 pre-programmed transfers
- Fast analog-to-digital converter (ADC)
  - Eight analog input channels
  - 12-bit resolution
  - Minimum 1.125 µs conversion time
  - Simultaneous sampling of two channels for motor control applications
  - Single-scan or continuous operation
  - Optional interrupts on conversion complete, zero crossing (sign change), or under/over low/high limit
  - Unused analog channels can be used as digital I/O

- Four 32-bit DMA timers
  - 17-ns resolution at 60 MHz
  - Programmable sources for clock input, including an external clock option
  - Programmable prescaler
  - Input capture capability with programmable trigger edge on input pin
  - Output compare with programmable mode for the output pin
  - Free run and restart modes
  - Maskable interrupts on input capture or output compare
  - DMA trigger capability on input capture or output compare
- Four-channel general purpose timers
  - 16-bit architecture
  - Programmable prescaler
  - Output pulse widths variable from microseconds to seconds
  - Single 16-bit input pulse accumulator
  - Toggle-on-overflow feature for pulse-width modulator (PWM) generation
  - One dual-mode pulse accumulation channel
- Pulse-width modulation timer
  - Operates as eight channels with 8-bit resolution or four channels with 16-bit resolution
  - Programmable period and duty cycle
  - Programmable enable/disable for each channel
  - Software selectable polarity for each channel
  - Period and duty cycle are double buffered. Change takes effect when the end of the current period is reached (PWM counter reaches zero) or when the channel is disabled.
  - Programmable center or left aligned outputs on individual channels
  - Four clock sources (A, B, SA, and SB) provide for a wide range of frequencies
  - Emergency shutdown
- Real-Time Clock (RTC)
  - Maintains system time-of-day clock
  - Provides stopwatch and alarm interrupt functions
- Two periodic interrupt timers (PITs)
  - 16-bit counter
  - Selectable as free running or count down
- Software watchdog timer
  - 32-bit counter
  - Low power mode support
- Clock Generation Features
  - Crystal input
  - On-chip PLL
  - Provides clock for integrated EPHY
- Dual Interrupt Controllers (INTC0/INTC1)
  - Support for multiple interrupt sources organized as follows:
    - Fully-programmable interrupt sources for each peripheral
    - 7 fixed-level interrupt sources
    - Seven external interrupt signals

  - Unique vector number for each interrupt source
  - Ability to mask any individual interrupt source or all interrupt sources (global mask-all)
  - Support for hardware and software interrupt acknowledge (IACK) cycles
  - Combinatorial path to provide wake-up from low power modes
- DMA controller
  - Four fully programmable channels
  - Dual-address transfer support with 8-, 16-, and 32-bit data capability, along with support for 16-byte (4 x 32-bit) burst transfers
  - Source/destination address pointers that can increment or remain constant
  - 24-bit byte transfer counter per channel
  - Auto-alignment transfers supported for efficient block movement
  - Bursting and cycle steal support
  - Software-programmable DMA requesters for the UARTs (3) and 32-bit timers (4)
- Reset
  - Separate reset in and reset out signals
  - Seven sources of reset:
    - Power-on reset (POR)
    - External
    - Software
    - Watchdog
    - Loss of clock
    - Loss of lock
    - Low-voltage detection (LVD)
  - Status flag indication of source of last reset
- Chip integration module (CIM)
  - System configuration during reset
  - Selects one of three clock modes
  - Configures output pad drive strength
  - Unique part identification number and part revision number
- General purpose I/O interface
  - Up to 56 bits of general purpose I/O
  - Bit manipulation supported via set/clear functions
  - Programmable drive strengths
  - Unused peripheral pins may be used as extra GPIO
- JTAG support for system level board testing

1.2.2 V2 Core Overview

The version 2 ColdFire processor core is comprised of two separate pipelines decoupled by an instruction buffer. The two-stage instruction fetch pipeline (IFP) is responsible for instruction-address generation and instruction fetch. The instruction buffer is a first-in-first-out (FIFO) buffer that holds prefetched instructions awaiting execution in the operand execution pipeline (OEP). The OEP includes two pipeline stages. The first stage decodes instructions and selects operands (DSOC); the second stage (AGEX) performs instruction execution and calculates operand effective addresses, if needed.

The V2 core implements the ColdFire instruction set architecture revision A+ with added support for a separate user stack pointer register and four new instructions to assist in bit processing. Additionally, the MCF52235 core includes the enhanced multiply-accumulate (EMAC) unit for improved signal processing capabilities. The EMAC implements a three-stage arithmetic

pipeline, optimized for 16×16 bit operations, with support for one 32-bit accumulator. Supported operands include 16- and 32-bit signed and unsigned integers, signed fractional operands, and a complete set of instructions to process these data types. The EMAC provides support for execution of DSP operations within the context of a single processor at a minimal hardware cost.

1.2.3 Integrated Debug Module

The ColdFire processor core debug interface is provided to support system debugging in conjunction with low-cost debug and emulator development tools. Through a standard debug interface, access debug information and real-time tracing capability is provided on 112-and 121-lead packages. This allows the processor and system to be debugged at full speed without the need for costly in-circuit emulators.

The on-chip breakpoint resources include a total of nine programmable 32-bit registers: an address and an address mask register, a data and a data mask register, four PC registers, and one PC mask register. These registers can be accessed through the dedicated debug serial communication channel or from the processor's supervisor mode programming model. The breakpoint registers can be configured to generate triggers by combining the address, data, and PC conditions in a variety of single- or dual-level definitions. The trigger event can be programmed to generate a processor halt or initiate a debug interrupt exception. The MCF52235 implements revision B+ of the ColdFire Debug Architecture.

The MCF52235's interrupt servicing options during emulator mode allow real-time critical interrupt service routines to be serviced while processing a debug interrupt event, thereby ensuring that the system continues to operate even during debugging.

To support program trace, the V2 debug module provides processor status (PST[3:0]) and debug data (DDATA[3:0]) ports. These buses and the PSTCLK output provide execution status, captured operand data, and branch target addresses defining processor activity at the CPU's clock rate. The MCF52235 includes a new debug signal, ALLPST. This signal is the logical AND of the processor status (PST[3:0]) signals and is useful for detecting when the processor is in a halted state (PST[3:0] = 1111).

The full debug/trace interface is available only on the 112 and 121-pin packages. However, every product features the dedicated debug serial communication channel (DSI, DSO, DSCLK) and the ALLPST signal.

1.2.4 JTAG

The MCF52235 supports circuit board test strategies based on the Test Technology Committee of IEEE and the Joint Test Action Group (JTAG). The test logic includes a test access port (TAP) consisting of a 16-state controller, an instruction register, and three test registers (a 1-bit bypass register, a 256-bit boundary-scan register, and a 32-bit ID register). The boundary scan register links the device's pins into one shift register. Test logic, implemented using static logic design, is independent of the device system logic.

The MCF52235 implementation can do the following:

- Perform boundary-scan operations to test circuit board electrical continuity
- Sample MCF52235 system pins during operation and transparently shift out the result in the boundary scan register
- Bypass the MCF52235 for a given circuit board test by effectively reducing the boundary-scan register to a single bit
- Disable the output drive to pins during circuit-board testing
- Drive output pins to stable levels

1.2.5 On-Chip Memories

1.2.5.1 SRAM

The dual-ported SRAM module provides a general-purpose 16- or 32-Kbyte memory block that the ColdFire core can access in a single cycle. The location of the memory block can be set to any 16- or 32-Kbyte boundary within the 4-Gbyte address space. This memory is ideal for storing critical code or data structures and for use as the system stack. Because the SRAM

module is physically connected to the processor's high-speed local bus, it can quickly service core-initiated accesses or memory-referencing commands from the debug module.

The SRAM module is also accessible by the DMA. The dual-ported nature of the SRAM makes it ideal for implementing applications with double-buffer schemes, where the processor and a DMA device operate in alternate regions of the SRAM to maximize system performance.

1.2.5.2 Flash

The ColdFire flash module (CFM) is a non-volatile memory (NVM) module that connects to the processor's high-speed local bus. The CFM is constructed with four banks of 32 K×16-bit flash arrays to generate 256 Kbytes of 32-bit flash memory. These arrays serve as electrically erasable and programmable, non-volatile program and data memory. The flash memory is ideal for program and data storage for single-chip applications, allowing for field reprogramming without requiring an external high voltage source. The CFM interfaces to the ColdFire core through an optimized read-only memory controller which supports interleaved accesses from the 2-cycle flash arrays. A backdoor mapping of the flash memory is used for all program, erase, and verify operations, as well as providing a read datapath for the DMA. Flash memory may also be programmed via the EzPort, which is a serial flash programming interface that allows the flash to be read, erased and programmed by an external controller in a format compatible with most SPI bus flash memory chips. This allows easy device programming via Automated Test Equipment or bulk programming tools.

1.2.6 Cryptography Acceleration Unit

The MCF52235 device incorporates two hardware accelerators for cryptographic functions. First, the CAU is a coprocessor tightly-coupled to the V2 ColdFire core that implements a set of specialized operations to increase the throughput of software-based encryption and message digest functions, specifically the DES, 3DES, AES, MD5 and SHA-1 algorithms. Second, a random number generator provides FIPS-140 compliant 32-bit values to security processing routines. Both modules supply critical acceleration to software-based cryptographic algorithms at a minimal hardware cost.

1.2.7 Power Management

The MCF52235 incorporates several low-power modes of operation which are entered under program control and exited by several external trigger events. An integrated power-on reset (POR) circuit monitors the input supply and forces an MCU reset as the supply voltage rises. The low voltage detector (LVD) monitors the supply voltage and is configurable to force a reset or interrupt condition if it falls below the LVD trip point.

1.2.8 FlexCAN

The FlexCAN module is a communication controller implementing version 2.0 of the CAN protocol parts A and B. The CAN protocol can be used as an industrial control serial data bus, meeting the specific requirements of reliable operation in a harsh EMI environment with high bandwidth. This instantiation of FlexCAN has 16 message buffers.

1.2.9 UARTs

The MCF52235 has three full-duplex UARTs that function independently. The three UARTs can be clocked by the system bus clock, eliminating the need for an external clock source. On smaller packages, the third UART is multiplexed with other digital I/O functions.

1.2.10 I²C Bus

The I²C bus is a two-wire, bidirectional serial bus that provides a simple, efficient method of data exchange and minimizes the interconnection between devices. This bus is suitable for applications requiring occasional communications over a short distance between many devices on a circuit board.

1.2.11 QSPI

The queued serial peripheral interface (QSPI) provides a synchronous serial peripheral interface with queued transfer capability. It allows up to 16 transfers to be queued at once, minimizing the need for CPU intervention between transfers.

1.2.12 Fast ADC

The Fast ADC consists of an eight-channel input select multiplexer and two independent sample and hold (S/H) circuits feeding separate 10- or 12-bit ADCs. The two separate converters store their results in accessible buffers for further processing.

The ADC can be configured to perform a single scan and halt, perform a scan whenever triggered, or perform a programmed scan sequence repeatedly until manually stopped.

The ADC can be configured for sequential or simultaneous conversion. When configured for sequential conversions, up to eight channels can be sampled and stored in any order specified by the channel list register. Both ADCs may be required during a scan, depending on the inputs to be sampled.

During a simultaneous conversion, both S/H circuits are used to capture two different channels at the same time. This configuration requires that a single channel may not be sampled by both S/H circuits simultaneously.

Optional interrupts can be generated at the end of the scan sequence if a channel is out of range (measures below the low threshold limit or above the high threshold limit set in the limit registers) or at several different zero crossing conditions.

1.2.13 DMA Timers (DTIM0–DTIM3)

There are four independent, DMA transfer capable 32-bit timers (DTIM0, DTIM1, DTIM2, and DTIM3) on the each device. Each module incorporates a 32-bit timer with a separate register set for configuration and control. The timers can be configured to operate from the system clock or from an external clock source using one of the DTINx signals. If the system clock is selected, it can be divided by 16 or 1. The input clock is further divided by a user-programmable 8-bit prescaler which clocks the actual timer counter register (TCRn). Each of these timers can be configured for input capture or reference (output) compare mode. Timer events may optionally cause interrupt requests or DMA transfers.

1.2.14 General Purpose Timer (GPT)

The general purpose timer (GPT) is a 4-channel timer module consisting of a 16-bit programmable counter driven by a 7-stage programmable prescaler. Each of the four channels can be configured for input capture or output compare. Additionally, one of the channels, channel 3, can be configured as a pulse accumulator.

A timer overflow function allows software to extend the timing capability of the system beyond the 16-bit range of the counter. The input capture and output compare functions allow simultaneous input waveform measurements and output waveform generation. The input capture function can capture the time of a selected transition edge. The output compare function can generate output waveforms and timer software delays. The 16-bit pulse accumulator can operate as a simple event counter or a gated time accumulator.

1.2.15 Periodic Interrupt Timers (PIT0 and PIT1)

The two periodic interrupt timers (PIT0 and PIT1) are 16-bit timers that provide interrupts at regular intervals with minimal processor intervention. Each timer can count down from the value written in its PIT modulus register or can be a free-running down-counter.

1.2.16 Pulse Width Modulation (PWM) Timers

The MCF52235 has an 8-channel, 8-bit PWM timer. Each channel has a programmable period and duty cycle as well as a dedicated counter. Each of the modulators can create independent continuous waveforms with software-selectable duty rates from 0 to 100%. The PWM outputs have programmable polarity and can be programmed as left-aligned outputs or center-aligned outputs. For higher period and duty cycle resolution, each pair of adjacent channels ([7:6], [5:4], [3:2], and [1:0]) can be concatenated to form a single 16-bit channel. The module can, therefore, be configured to support 8/0, 6/1, 4/2, 2/3, or 0/4 8-/16-bit channels.

1.2.17 Software Watchdog Timer

The watchdog timer is a 32-bit timer that facilitates recovery from runaway code. The watchdog counter is a free-running down-counter that generates a reset on underflow. To prevent a reset, software must periodically restart the countdown.

1.2.18 Phase Locked Loop (PLL)

The clock module contains a crystal oscillator, 8 MHz on-chip relaxation oscillator (OCO), phase-locked loop (PLL), reduced frequency divider (RFD), low-power divider status/control registers, and control logic. To improve noise immunity, the PLL, crystal oscillator, and relaxation oscillator have their own power supply inputs: VDDPLL and VSSPLL. All other circuits are powered by the normal supply pins, VDD and VSS.

1.2.19 Interrupt Controller (INTC0/INTC1)

There are two interrupt controllers on the MCF52235. These interrupt controllers are organized as seven levels with up to nine interrupt sources per level. Each interrupt source has a unique interrupt vector, and provide each peripheral with all necessary interrupts. Each internal interrupt has a programmable level [1-7] and priority within the level. The seven external interrupts have fixed levels/priorities.

1.2.20 DMA Controller

The direct memory access (DMA) controller provides an efficient way to move blocks of data with minimal processor intervention. It has four channels that allow byte, word, longword, or 16-byte burst line transfers. These transfers are triggered by software explicitly setting a DCRn[START] bit or by the occurrence of certain UART or DMA timer events.

1.2.21 Reset

The reset controller determines the source of reset, asserts the appropriate reset signals to the system, and keeps track of what caused the last reset. There are seven sources of reset:

- External reset input
- Power-on reset (POR)
- Watchdog timer
- Phase locked-loop (PLL) loss of lock
- PLL loss of clock
- Software

- Low-voltage detector (LVD)

Control of the LVD and its associated reset and interrupt are managed by the reset controller. Other registers provide status flags indicating the last source of reset and a control bit for software assertion of the $\overline{\text{RSTO}}$ pin.

1.2.22 GPIO

Nearly all pins on the MCF52235 have general purpose I/O capability in addition to their primary functions and are grouped into 8-bit ports. Some ports do not utilize all 8 bits. Each port has registers that configure, monitor, and control the port pins.

1.2.23 Part Numbers and Packaging

Table 2. Orderable Part Number Summary

Freescale Part Number	Description	Speed (MHz)	Flash/SRAM (Kbytes)	Package	Temp range (°C)
MCF52230CAF60	MCF52230 Microcontroller	60	128 / 32	80 LQFP	-40 to +85
MCF52230CAL60	MCF52230 Microcontroller	60	128 / 32	112 LQFP	-40 to +85
MCF52231CAF60	MCF52231 Microcontroller, FlexCAN	60	128 / 32	80 LQFP	-40 to +85
MCF52231CAL60	MCF52231 Microcontroller, FlexCAN	60	128 / 32	112 LQFP	-40 to +85
MCF52232CAF50	MCF52232 Microcontroller	50	128 / 32	80 LQFP	-40 to +85
MCF52232AF50	MCF52232 Microcontroller	50	128 / 32	80 LQFP	0 to +70
MCF52233CAF60	MCF52233 Microcontroller	60	256 / 32	80 LQFP	-40 to +85
MCF52233CAL60	MCF52233 Microcontroller	60	256 / 32	112 LQFP	-40 to +85
MCF52233CAL60A	MCF52233 Microcontroller	60	256 / 32	112 LQFP	-40 to +85
MCF52233CVM60	MCF52233 Microcontroller	60	256 / 32	121 MAPBGA	-40 to +85
MCF52234CAL60	MCF52234 Microcontroller, FlexCAN	60	256 / 32	112 LQFP	-40 to +85
MCF52234CVM60	MCF52234 Microcontroller, FlexCAN	60	256 / 32	121 MAPBGA	-40 to +85
MCF52235CAL60	MCF52235 Microcontroller, FlexCAN, CAU, RNGA	60	256 / 32	112 LQFP	-40 to +85
MCF52235CAL60A	MCF52235 Microcontroller, FlexCAN, CAU, RNGA	60	256 / 32	112 LQFP	-40 to +85
MCF52235CVM60	MCF52235 Microcontroller, FlexCAN, CAU, RNGA	60	256 / 32	121 MAPBGA	-40 to +85
MCF52236CAF50	MCF52236 Microcontroller	50	256 / 32	80 LQFP	-40 to +85
MCF52236AF50	MCF52236 Microcontroller	50	256 / 32	80 LQFP	0 to +70
MCF52236AF50A	MCF52236 Microcontroller	50	256 / 32	80 LQFP	0 to +70

1.2.24 Package Pinouts

Figure 2 shows the pinout configuration for the 80-pin LQFP.

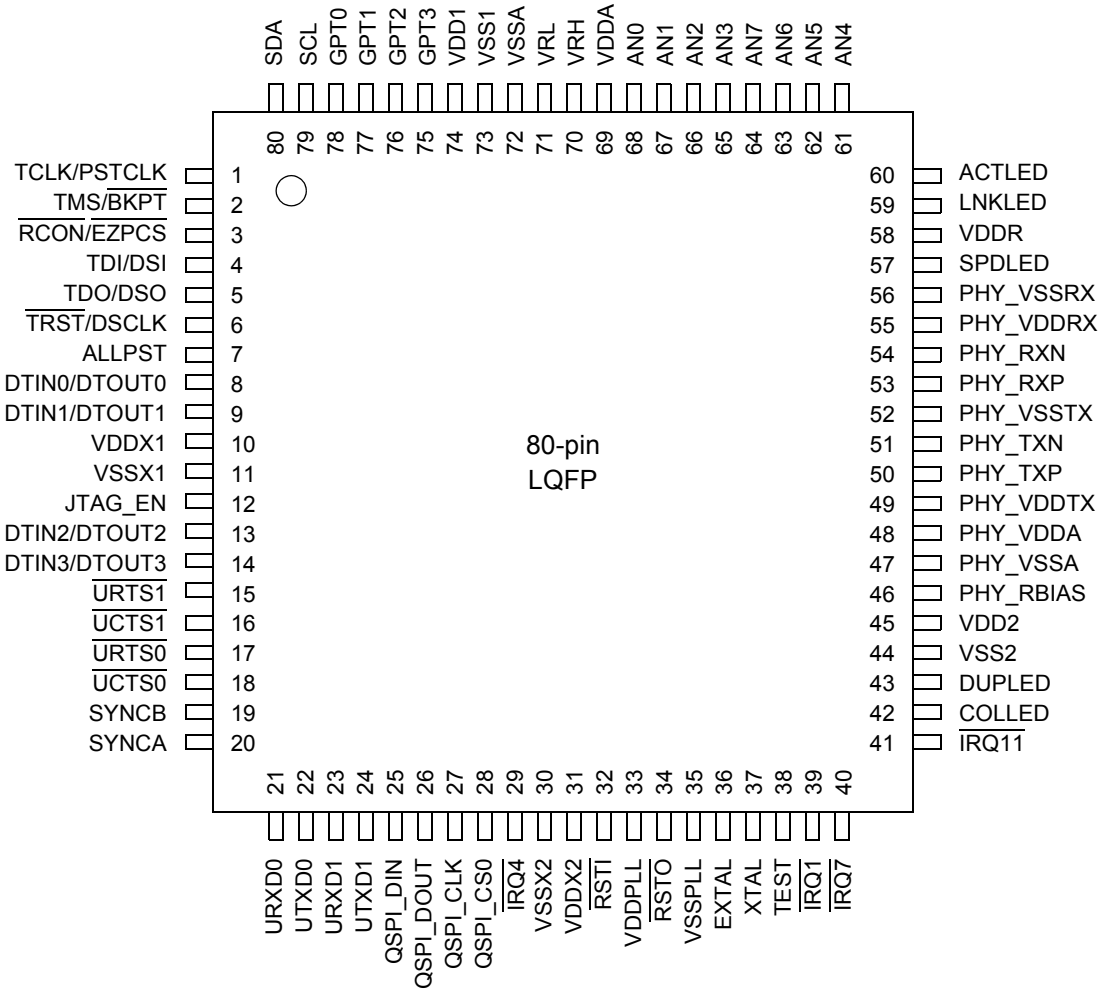


Figure 2. 80-pin LQFP Pin Assignments

Figure 3 shows the pinout configuration for the 112-pin LQFP.

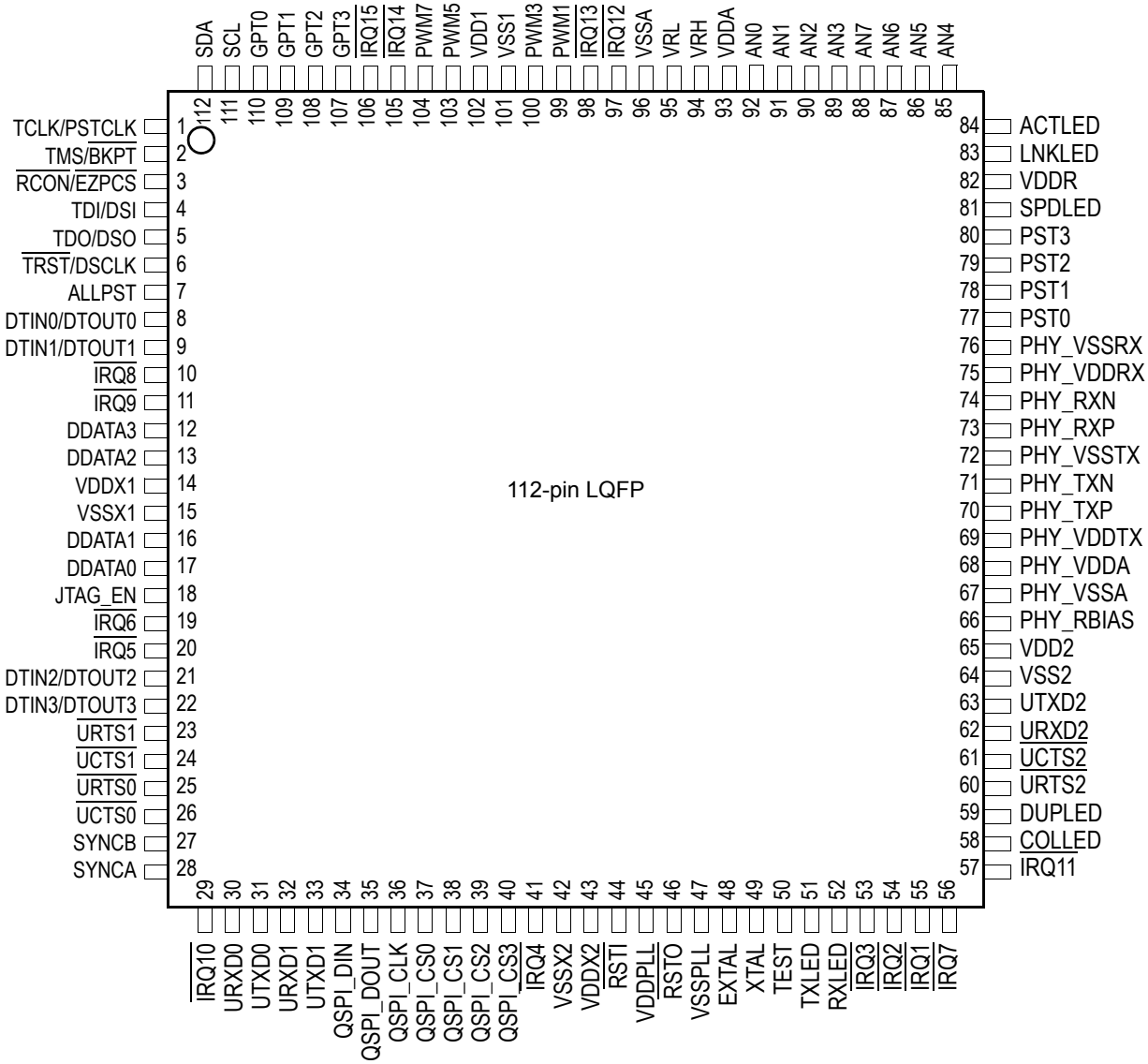


Figure 3. 112-pin LQFP Pin Assignments

Figure 4 shows the pinout configuration for the 121 MAPBGA.

	1	2	3	4	5	6	7	8	9	10	11
A	TCLK	SDA	SCL	$\overline{\text{IRQ15}}$	$\overline{\text{IRQ14}}$	$\overline{\text{IRQ13}}$	VSSA	VDDA	AN1	AN7	AN5
B	TMS	$\overline{\text{RCON}}$	GPT0	GPT3	PWM5	PWM1	VRL	VRH	AN2	AN6	AN4
C	$\overline{\text{TRST}}$	TDO	TDI	GPT2	PWM7	PWM3	$\overline{\text{IRQ12}}$	AN0	AN3	LNKLED	ACTLED
D	DTIN1	DTIN0	ALLPST	GPT1	VDDX	VDDX	VDD	VDDR	PST2	PST3	SPDLED
E	DDATA3	$\overline{\text{IRQ9}}$	$\overline{\text{IRQ8}}$	VSS	VSS	VDDX	VSS	VDD	PST0	PST1	PHY_RXN
F	DDATA0	DDATA1	DDATA2	VSS	VSS	VSS	VSS	VSS	PHY_VSSRX	PHY_VDDRX	PHY_RXP
G	DTIN2	$\overline{\text{IRQ5}}$	$\overline{\text{IRQ6}}$	JTAG_EN	VDDX	VDDX	VDDX	PHY_VSSA	PHY_VSSTX	PHY_VDDTX	PHY_TXP
H	DTIN3	$\overline{\text{URTS0}}$	$\overline{\text{URTS1}}$	QSPI_DIN	QSPI_CS1	VDDX	TEST	TXLED	RXLED	PHY_VDDA	PHY_TXN
J	SYNCB	$\overline{\text{UCTS0}}$	$\overline{\text{UCTS1}}$	QSPI_DOUT	QSPI_CS2	$\overline{\text{RSTI}}$	XTAL	$\overline{\text{IRQ1}}$	COLLED	DUPLED	PHY_RBIAS
K	SYNCA	URXD0	URXD1	QSPI_CLK	QSPI_CS3	VDDPLL	VSSPLL	$\overline{\text{IRQ2}}$	$\overline{\text{IRQ11}}$	$\overline{\text{URTS2}}$	URXD2
L	$\overline{\text{IRQ10}}$	UTXD0	UTXD1	QSPI_CS0	$\overline{\text{IRQ4}}$	$\overline{\text{RSTO}}$	EXTAL	$\overline{\text{IRQ3}}$	$\overline{\text{IRQ7}}$	$\overline{\text{UCTS2}}$	UTXD2

Figure 4. 121 MAPBGA Pin Assignments

Table 3. Pin Functions by Primary and Alternate Purpose

Pin Group	Primary Function	SecondaryFunction	Tertiary Function	Quaternary Function	Drive Strength/ Control[1]	Wired OR Control	Pull-up/ Pull-down[2]	Pin on 121 MAPBGA	Pin on 112 LQFP	Pin on 80 LQFP
ADC[3]	AN7	—	—	PAN[7]	Low	—	—	A10	88	64
	AN6	—	—	PAN[6]	Low	—	—	B10	87	63
	AN5	—	—	PAN[5]	Low	—	—	A11	86	62
	AN4	—	—	PAN[4]	Low	—	—	B11	85	61
	AN3	—	—	PAN[3]	Low	—	—	C9	89	65
	AN2	—	—	PAN[2]	Low	—	—	B9	90	66
	AN1	—	—	PAN[1]	Low	—	—	A9	91	67
	AN0	—	—	PAN[0]	Low	—	—	C8	92	68
	SYNCA	CANTX[4]	FEC_MDIO	PAS[3]	PDSR[39]	—	—	K1	28	20
	SYNCB	CANRX[4]	FEC_MDC	PAS[2]	PDSR[39]	—	—	J1	27	19
	VDDA	—	—	—	N/A	N/A	—	A8	93	69
	VSSA	—	—	—	N/A	N/A	—	A7	96	72
	VRH	—	—	—	N/A	N/A	—	B8	94	70
	VRL	—	—	—	N/A	N/A	—	B7	95	71
Clock Generation	EXTAL	—	—	—	N/A	N/A	—	L7	48	36
	XTAL	—	—	—	N/A	N/A	—	J7	49	37
	VDDPLL[5]	—	—	—	N/A	N/A	—	K6	45	33
	VSSPLL	—	—	—	N/A	N/A	—	K7	47	35
Debug Data	ALLPST	—	—	—	High	—	—	D3	7	7
	DDATA[3:0]	—	—	PDD[7:4]	High	—	—	E1, F3,F2, F1	12,13,16,17	—
	PST[3:0]	—	—	PDD[3:0]	High	—	—	D10, D9, E10, E9	80,79,78,77	—

Table 3. Pin Functions by Primary and Alternate Purpose (continued)

Pin Group	Primary Function	SecondaryFunction	Tertiary Function	Quaternary Function	Drive Strength/ Control[1]	Wired OR Control	Pull-up/ Pull-down[2]	Pin on 121 MAPBGA	Pin on 112 LQFP	Pin on 80 LQFP
Ethernet LEDs	ACTLED	—	—	PLD[0]	PDSR[32]	PWOR[8]	—	C11	84	60
	COLLED	—	—	PLD[4]	PDSR[36]	PWOR[12]	—	J9	58	42
	DUPLED	—	—	PLD[3]	PDSR[35]	PWOR[11]	—	J10	59	43
	LNKLED	—	—	PLD[1]	PDSR[33]	PWOR[9]	—	C10	83	59
	SPDLED	—	—	PLD[2]	PDSR[34]	PWOR[10]	—	D11	81	57
	RXLED	—	—	PLD[5]	PDSR[37]	PWOR[13]	—	H9	52	—
	TXLED	—	—	PLD[6]	PDSR[38]	PWOR[14]	—	H8	51	—
	VDDR	—	—	—	—	—	—	D8	82	58
Ethernet PHY	PHY_RBIAS	—	—	—	—	—		J11	66	46
	PHY_RXN	—	—	—	—	—		E11	74	54
	PHY_RXP	—	—	—	—	—		F11	73	53
	PHY_TXN	—	—	—	—	—		H11	71	51
	PHY_TXP	—	—	—	—	—		G11	70	50
	PHY_VDDA[5]	—	—	—		N/A		H10	68	48
	PHY_VDDRX[5]	—	—	—		N/A		F10	75	55
	PHY_VDDTX[5]	—	—	—		N/A		G10	69	49
	PHY_VSSA	—	—	—		N/A		G8	67	47
	PHY_VSSRX	—	—	—		N/A		F9	76	56
	PHY_VSSTX	—	—	—		N/A		G9	72	52
I^2C	SCL	CANTX[4]	UTXD2	PAS[0]	PDSR[0]	—	Pull-Up[6]	A3	111	79
	SDA	CANRX[4]	URXD2	PAS[1]	PDSR[0]	—	Pull-Up[6]	A2	112	80
Interrupts[3]	IRQ15	—	—	PGP[7]	PSDR[47]	—	Pull-Up[6]	A4	106	—
	IRQ14	—	—	PGP[6]	PSDR[46]	—	Pull-Up[6]	A5	105	—
	IRQ13	—	—	PGP[5]	PSDR[45]	—	Pull-Up[6]	A6	98	—
	IRQ12	—	—	PGP[4]	PSDR[44]	—	Pull-Up[6]	C7	97	—

Table 3. Pin Functions by Primary and Alternate Purpose (continued)

Pin Group	Primary Function	SecondaryFunction	Tertiary Function	Quaternary Function	Drive Strength/ Control[1]	Wired OR Control	Pull-up/ Pull-down[2]	Pin on 121 MAPBGA	Pin on 112 LQFP	Pin on 80 LQFP
Continued Interrupts[3]	IRQ11	—	—	PGP[3]	PSDR[43]	—	Pull-Up[6]	K9	57	41
	IRQ10	—	—	PGP[2]	PSDR[42]	—	Pull-Up[6]	L1	29	—
	IRQ9	—	—	PGP[1]	PSDR[41]	—	Pull-Up[6]	E2	11	—
	IRQ8	—	—	PGP[0]	PSDR[40]	—	Pull-Up	E3	10	—
	IRQ7	—	—	PNQ[7]	Low	—	Pull-Up[6]	L9	56	40
	IRQ6	—	FEC_RXER	PNQ[6]	Low	—	Pull-Up[6]	G3	19	—
	IRQ5	—	FEC_RXD[1]	PNQ[5]	Low	—	Pull-Up[6]	G2	20	—
	IRQ4	—	—	PNQ[4]	Low	—	Pull-Up[6]	L5	41	29
	IRQ3	—	FEC_RXD[2]	PNQ[3]	Low	—	Pull-Up[6]	L8	53	—
	IRQ2	—	FEC_RXD[3]	PNQ[2]	Low	—	Pull-Up[6]	K8	54	—
	IRQ1	SYNCA	PWM1	PNQ[1]	High	—	Pull-Up[6]	J8	55	39
JTAG/BDM	JTAG_EN	—	—	—	N/A	N/A	Pull-Down	G4	18	12
	TCLK/ PSTCLK	CLKOUT	—	—	High	—	Pull-Up[7]	A1	1	1
	TDI/DSI	—	—	—	N/A	N/A	Pull-Up[7]	C3	4	4
	TDO/DSO	—	—	—	High	N/A	—	C2	5	5
	TMS/$\overline{\text{BKPT}}$	—	—	—	N/A	N/A	Pull-Up[7]	B1	2	2
	TRST/DSCLK	—	—	—	N/A	N/A	Pull-Up	C1	6	6
Mode Selection	$\overline{\text{RCON}}$/EZPCS	—	—	—	N/A	N/A	Pull-Up	B2	3	3
PWM	PWM7	—	—	PTD[3]	PDSR[31]	—	—	C5	104	—
	PWM5	—	—	PTD[2]	PDSR[30]	—	—	B5	103	—
	PWM3	—	—	PTD[1]	PDSR[29]	—	—	C6	100	—
	PWM1	—	—	PTD[0]	PDSR[28]	—	—	B6	99	—

Table 3. Pin Functions by Primary and Alternate Purpose (continued)

Pin Group	Primary Function	SecondaryFunction	Tertiary Function	Quaternary Function	Drive Strength/ Control[1]	Wired OR Control	Pull-up/ Pull-down[2]	Pin on 121 MAPBGA	Pin on 112 LQFP	Pin on 80 LQFP
QSPI[3]	QSPI_DIN/ EZPD	CANRX[4]	URXD1	PQS[1]	PDSR[2]	PWOR[4]	—	H4	34	25
	QSPI_DOUT/EZPQ	CANTX[4]	UTXD1	PQS[0]	PDSR[1]	PWOR[5]	—	J4	35	26
	QSPI_CLK/ EZPCK	SCL	URTS1	PQS[2]	PDSR[3]	PWOR[6]	Pull-Up[8]	K4	36	27
	QSPI_CS3	SYNCA	SYNCB	PQS[6]	PDSR[7]	—	—	K5	40	—
	QSPI_CS2	—	FEC_TXCLK	PQS[5]	PDSR[6]	—	—	J5	39	—
	QSPI_CS1	—	FEC_TXEN	PQS[4]	PDSR[5]	—	—	H5	38	—
	QSPI_CS0	SDA	UCTS1	PQS[3]	PDSR[4]	PWOR[7]	Pull-Up[8]	L4	37	28
Reset[9]	RSTI	—	—	—	N/A	N/A	Pull-Up[9]	J6	44	32
	RSTO	—	—	—	high	—	—	L6	46	34
Test	TEST	—	—	—	N/A	N/A	Pull-Down	H7	50	38
Timers, 16-bit[3]	GPT3	FEC_TXD[3]	PWM7	PTA[3]	PDSR[23]	—	Pull-Up[10]	B4	107	75
	GPT2	FEC_TXD[2]	PWM5	PTA[2]	PDSR[22]	—	Pull-Up[10]	C4	108	76
	GPT1	FEC_TXD[1]	PWM3	PTA[1]	PDSR[21]	—	Pull-Up[10]	D4	109	77
	GPT0	FEC_TXER	PWM1	PTA[0]	PDSR[20]	—	Pull-Up[10]	B3	110	78
Timers, 32-bit	DTIN3	DTOUT3	PWM6	PTC[3]	PDSR[19]	—	—	H1	22	14
	DTIN2	DTOUT2	PWM4	PTC[2]	PDSR[18]	—	—	G1	21	13
	DTIN1	DTOUT1	PWM2	PTC[1]	PDSR[17]	—	—	D1	9	9
	DTIN0	DTOUT0	PWM0	PTC[0]	PDSR[16]	—	—	D2	8	8
UART 0[3]	$\overline{\text{UCTS0}}$	CANRX[4]	FEC_RXCLK	PUA[3]	PDSR[11]	—	—	J2	26	18
	$\overline{\text{URTS0}}$	CANTX[4]	FEC_RXDV	PUA[2]	PDSR[10]	—	—	H2	25	17
	URXD0	—	FEC_RXD[0]	PUA[1]	PDSR[9]	PWOR[0]	—	K2	30	21
	UTXD0	—	FEC_CRS	PUA[0]	PDSR[8]	PWOR[1]	—	L2	31	22

Table 3. Pin Functions by Primary and Alternate Purpose (continued)

Pin Group	Primary Function	SecondaryFunction	Tertiary Function	Quaternary Function	Drive Strength/ Control[1]	Wired OR Control	Pull-up/ Pull-down[2]	Pin on 121 MAPBGA	Pin on 112 LQFP	Pin on 80 LQFP
UART 1[3]	$\overline{\text{UCTS1}}$	SYNCA	URXD2	PUB[3]	PDSR[15]	—	—	J3	24	16
	$\overline{\text{URTS1}}$	SYNCB	UTXD2	PUB[2]	PDSR[14]	—	—	H3	23	15
	URXD1	—	FEC_TXD[0]	PUB[1]	PDSR[13]	PWOR[2]	—	K3	32	23
	UTXD1	—	FEC_COL	PUB[0]	PDSR[12]	PWOR[3]	—	L3	33	24
UART 2	$\overline{\text{UCTS2}}$	—	—	PUC[3]	PDSR[27]	—	—	L10	61	—
	$\overline{\text{URTS2}}$	—	—	PUC[2]	PDSR[26]	—	—	K10	60	—
	URXD2	—	—	PUC[1]	PDSR[25]	—	—	K11	62	—
	UTXD2	—	—	PUC[0]	PDSR[24]	—	—	L11	63	—
FlexCAN	SYNCA	CANTX[4]	FEC_MDIO	PAS[3]	PDSR[39]	—	—	—	28	20
	SYNCB	CANRX[4]	FEC_MDC	PAS[2]	PDSR[39]	—	—	—	27	19
VDD[5,11]	VDD	—	—	—	N/A	N/A	—	D7, E8	65,102	45,74
VDDX	VDDX	—	—	—	N/A	N/A	—	D5, D6, E6, G5, G6, G7, H6	14, 43	10, 31
VSS	VSS	—	—	—	N/A	N/A	—	E4, E5, E7,F4, F5, F6, F7, F8	64,101	44,73
VSSX	VSSX	—	—	—	N/A	N/A	—	—	15, 42	11, 30

1 The PDSR and PSSR registers are described in Chapter 14, "General Purpose I/O Module. All programmable signals default to 2mA drive in normal (single-chip) mode.
2 All signals have a pull-up in GPIO mode.
3 The use of an external PHY limits ADC, interrupt, and QSPI functionality. It also disables the UART0/1 and timer pins.
4 The multiplexed CANTX and CANRX signals do not have dedicated pins, but are available as muxed replacements for other signals.
5 The VDD1, VDD2, VDDPLL, and PHY_VDD pins are for decoupling only and should not have power directly applied to them.
6 For primary and GPIO functions only.
7 Only when JTAG mode is enabled.
8 For secondary and GPIO functions only.
9 RSTI has an internal pull-up resistor; however, the use of an external resistor is strongly recommended.
10 For GPIO function. Primary Function has pull-up control within the GPT module.
11 This list for power and ground does not include those dedicated power/ground pins included elsewhere, e.g. in the Ethernet PHY.

1.3 Reset Signals

Table 4 describes signals that are used to either reset the chip or as a reset indication.

Table 4. Reset Signals

Signal Name	Abbreviation	Function	I/O
Reset In	$\overline{\text{RSTI}}$	Primary reset input to the device. Asserting $\overline{\text{RSTI}}$ immediately resets the CPU and peripherals.	I
Reset Out	$\overline{\text{RSTO}}$	Driven low for 512 CPU clocks after the reset source has deasserted.	O

1.4 PLL and Clock Signals

Table 5 describes signals that are used to support the on-chip clock generation circuitry.

Table 5. PLL and Clock Signals

Signal Name	Abbreviation	Function	I/O
External Clock In	EXTAL	Crystal oscillator or external clock input.	I
Crystal	XTAL	Crystal oscillator output.	O
Clock Out	CLKOUT	This output signal reflects the internal system clock.	O

1.5 Mode Selection

Table 6 describes signals used in mode selection, Table 6 describes particular clocking modes.

Table 6. Mode Selection Signals

Signal Name	Abbreviation	Function	I/O
Reset Configuration	RCON	The Serial Flash Programming mode is entered by asserting the $\overline{\text{RCON}}$ pin (with the TEST pin negated) as the chip comes out of reset. During this mode, the EzPort has access to the Flash memory which can be programmed from an external device.	—
Test	TEST	Reserved for factory testing only and in normal modes of operation should be connected to VSS to prevent unintentional activation of test functions.	I

1.6 External Interrupt Signals

Table 7 describes the external interrupt signals.

Table 7. External Interrupt Signals

Signal Name	Abbreviation	Function	I/O
External Interrupts	$\overline{\text{IRQ}}$[15:1]	External interrupt sources.	I

1.7 Queued Serial Peripheral Interface (QSPI)

Table 8 describes QSPI signals.

Table 8. Queued Serial Peripheral Interface (QSPI) Signals

Signal Name	Abbreviation	Function	I/O
QSPI Synchronous Serial Output	QSPI_DOUT	Provides the serial data from the QSPI and can be programmed to be driven on the rising or falling edge of QSPI_CLK.	O
QSPI Synchronous Serial Data Input	QSPI_DIN	Provides the serial data to the QSPI and can be programmed to be sampled on the rising or falling edge of QSPI_CLK.	I
QSPI Serial Clock	QSPI_CLK	Provides the serial clock from the QSPI. The polarity and phase of QSPI_CLK are programmable.	O
Synchronous Peripheral Chip Selects	QSPI_CS[3:0]	QSPI peripheral chip selects that can be programmed to be active high or low.	O

1.8 Fast Ethernet Controller EPHY Signals

Table 9 describes the Fast Ethernet Controller (FEC) signals.

Table 9. Fast Ethernet Controller (FEC) Signals

Signal Name	Abbreviation	Function	I/O
Twisted Pair Input +	RXP	Differential Ethernet twisted-pair input pin. This pin is high-impedance out of reset.	I
Twisted Pair Input -	RXN	Differential Ethernet twisted-pair input pin. This pin is high-impedance out of reset.	I
Twisted Pair Output +	TXN	Differential Ethernet twisted-pair output pin. This pin is high-impedance out of reset.	O
Twisted Pair Output -	TXP	Differential Ethernet twisted-pair output pin. This pin is high-impedance out of reset.	O
Bias Control Resistor	RBIAS	Connect a 12.4 kΩ (1.0%) external resistor, RBIAS, between the PHY_RBIAS pin and analog ground. Place this resistor as near to the chip pin as possible. Stray capacitance must be kept to less than 10 pF (>50 pF causes instability). No high-speed signals can be permitted in the region of RBIAS.	I
Activity LED	ACT_LED	Indicates when the EPHY is transmitting or receiving	O
Link LED	LINK_LED	Indicates when the EPHY has a valid link	O
Speed LED	SPD_LED	Indicates the speed of the EPHY connection	O
Duplex LED	DUPLED	Indicates the duplex (full or half) of the EPHY connection	O
Collision LED	COLLED	Indicates if the EPHY detects a collision	O
Transmit LED	TXLED	Indicates if the EPHY is transmitting	O
Receive LED	RXLED	Indicates if the EPHY is receiving	O

1.9 I²C I/O Signals

Table 10 describes the I²C serial interface module signals.

Table 10. I²C I/O Signals

Signal Name	Abbreviation	Function	I/O
Serial Clock	SCL	Open-drain clock signal for the for the I²C interface. Either it is driven by the I²C module when the bus is in master mode or it becomes the clock input when the I²C is in slave mode.	I/O
Serial Data	SDA	Open-drain signal that serves as the data input/output for the I²C interface.	I/O

1.10 UART Module Signals

Table 11 describes the UART module signals.

Table 11. UART Module Signals

Signal Name	Abbreviation	Function	I/O
Transmit Serial Data Output	UTXD*n*	Transmitter serial data outputs for the UART modules. The output is held high (mark condition) when the transmitter is disabled, idle, or in the local loopback mode. Data is shifted out, LSB first, on this pin at the falling edge of the serial clock source.	O
Receive Serial Data Input	URXD*n*	Receiver serial data inputs for the UART modules. Data is received on this pin LSB first. When the UART clock is stopped for power-down mode, any transition on this pin restarts it.	I
Clear-to-Send	$\overline{\text{UCTS}n}$	Indicate to the UART modules that they can begin data transmission.	I
Request-to-Send	$\overline{\text{URTS}n}$	Automatic request-to-send outputs from the UART modules. This signal can also be configured to be asserted and negated as a function of the RxFIFO level.	O

1.11 DMA Timer Signals

Table 12 describes the signals of the four DMA timer modules.

Table 12. DMA Timer Signals

Signal Name	Abbreviation	Function	I/O
DMA Timer Input	DTIN*n*	Event input to the DMA timer modules.	I
DMA Timer Output	DTOUT*n*	Programmable output from the DMA timer modules.	O

1.12 ADC Signals

Table 13 describes the signals of the Analog-to-Digital Converter.

Table 13. ADC Signals

Signal Name	Abbreviation	Function	I/O
Analog Inputs	AN[7:0]	Inputs to the A-to-D converter.	I
Analog Reference	V_{RH}	Reference voltage high and low inputs.	I
	V_{RL}		I
Analog Supply	V_{DDA}	Isolate the ADC circuitry from power supply noise	—
	V_{SSA}		—

1.13 General Purpose Timer Signals

Table 14 describes the General Purpose Timer Signals.

Table 14. GPT Signals

Signal Name	Abbreviation	Function	I/O
General Purpose Timer Input/Output	GPT[3:0]	Inputs to or outputs from the general purppose timer module	I/O

1.14 Pulse Width Modulator Signals

Table 15 describes the PWM signals.

Table 15. PWM Signals

Signal Name	Abbreviation	Function	I/O
PWM Output Channels	PWM[7:0]	Pulse width modulated output for PWM channels	O

1.15 Debug Support Signals

These signals are used as the interface to the on-chip JTAG controller and also to interface to the BDM logic.

Table 16. Debug Support Signals

Signal Name	Abbreviation	Function	I/O
JTAG Enable	JTAG_EN	Select between debug module and JTAG signals at reset	I
Test Reset	$\overline{\text{TRST}}$	This active-low signal is used to initialize the JTAG logic asynchronously.	I
Test Clock	TCLK	Used to synchronize the JTAG logic.	I
Test Mode Select	TMS	Used to sequence the JTAG state machine. TMS is sampled on the rising edge of TCLK.	I
Test Data Input	TDI	Serial input for test instructions and data. TDI is sampled on the rising edge of TCLK.	I